BUK104-50L/S **BUK104-50LP/SP**

DESCRIPTION

Monolithic temperature and overload protected logic level power MOSFET in a 5 pin plastic envelope, intended as a general purpose switch for automotive systems and other applications.

APPLICATIONS

General controller for driving

- lamps
- motors
- solenoids
- heaters

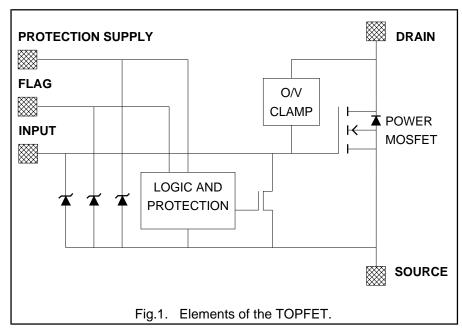
FEATURES

- Vertical power DMOS output stage
- Low on-state resistance
- Logic and protection supply from separate pin
- Low operating supply current
- Overload protection against over temperature
- Overload protection against short circuit load
- Latched overload protection reset by protection supply
- Protection circuit condition indicated by flag pin 5 V logic compatible input level
- Separate input pin for higher frequency drive
- ESD protection on input, flag and protection supply pins
- Over voltage clamping for turn off of inductive loads
- Both linear and switching operation are possible

QUICK REFERENCE DATA

SYMBOL	PARAMETER	MAX.	UNIT
V _{DS} I _D Ptot T _j R _{DS(ON)}	Continuous drain source voltage Continuous drain current Total power dissipation Continuous junction temperature Drain-source on-state resistance $ V_{\text{IS}} = 5 \text{ V} $ $V_{\text{IS}} = 7 \text{ V} $	50 15 40 150 125 100	V A V C $M\Omega$ $M\Omega$
SYMBOL	PARAMETER	NOM.	UNIT
V _{PSN}	Protection supply voltage BUK104-50L BUK104-50S	5 10	V

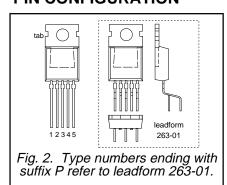
FUNCTIONAL BLOCK DIAGRAM



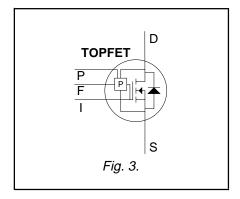
PINNING - SOT263

PIN	DESCRIPTION
1	input
2	flag
3	drain
4	protection supply
5	source
tab	drain

PIN CONFIGURATION



SYMBOL



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LIMITING VALUES

Limiting values in accordance with the Absolute Maximum Rating System (IEC 134)

SYMBOL	PARAMETER	CONDITIONS	MIN.	MAX.	UNIT
V _{DSS}	Voltages Continuous off-state drain source voltage ¹	V _{IS} = 0 V	-	50	٧
V _{IS} V _{FS} V _{PS}	Continuous input voltage Continuous flag voltage Continuous supply voltage	- - -	0 0 0	11 11 11	V V V
	Currents	V _{IS} =	-	7 5	V
I _D I _D I _{DRM}	Continuous drain current Continuous drain current Repetitive peak on-state drain current	$T_{mb} \le 25 ^{\circ}C$ $T_{mb} \le 100 ^{\circ}C$ $T_{mb} \le 25 ^{\circ}C$	- - -	15 13 9.5 8.5 60 54	A A A
$egin{array}{c} P_{tot} \ T_{stg} \ T_{j} \end{array}$	Thermal Total power dissipation Storage temperature Junction temperature ²	T _{mb} = 25 °C - continuous	- -55 -	40 150 150	ůů Š
T _{sold}	Lead temperature	during soldering	-	250	°C

OVERLOAD PROTECTION LIMITING VALUES

With the protection supply connected, TOPFET can protect itself from two types of overload - over temperature and short circuit load.

An n-MOS transistor turns on between the input and source to quickly discharge the power MOSFET gate capacitance.

For internal overload protection to remain latched while the control circuit is high, external series input resistance must be provided. Refer to INPUT CHARACTERISTICS.

SYMBOL	PARAMETER	CONDITIONS	MIN.		MIN.		MAX.	UNIT
		V _{IS} =	7	5	-	V		
V_{PSP}	Protection supply voltage ³	for valid protection BUK104-50L BUK104-50S	4.4 5.4	4 5		V V		
$V_{\text{DDP(T)}}$	Over temperature protection Protected drain source supply voltage	$ \begin{aligned} V_{PS} &= V_{PSN} \\ V_{IS} &= 10 \; V; \; R_I \geq 2 \; k\Omega \\ V_{IS} &= 5 \; V; \; R_I \geq 1 \; k\Omega \end{aligned} $		-	50 50	V		
$V_{DDP(P)}$ P_{DSM}	Short circuit load protection Protected drain source supply voltage ⁴ Instantaneous overload dissipation	$\begin{aligned} V_{PS} &= V_{PSN}; \ L \leq 10 \ \mu H \\ V_{IS} &= 10 \ V; \ R_I \geq 2 \ k \Omega \\ V_{IS} &= 5 \ V; \ R_I \geq 1 \ k \Omega \end{aligned}$		-	25 45 0.8	V V kW		

ESD LIMITING VALUE

SYMBOL	PARAMETER	CONDITIONS	MIN.	MAX.	UNIT
V _c	Electrostatic discharge capacitor voltage	Human body model; C = 250 pF; R = 1.5 kΩ	-	2	kV

¹ Prior to the onset of overvoltage clamping. For voltages above this value, safe operation is limited by the overvoltage clamping energy.

² A higher T_i is allowed as an overload condition but at the threshold T_{i(TO)} the over temperature trip operates to protect the switch.

³ The minimum supply voltage required for correct operation of the overload protection circuits.

⁴ The device is able to self-protect against a short circuit load providing the drain-source supply voltage does not exceed V_{DDP(P)} maximum. For further information, refer to OVERLOAD PROTECTION CHARACTERISTICS.

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Product specification

OVERVOLTAGE CLAMPING LIMITING VALUES

At a drain source voltage above 50 V the power MOSFET is actively turned on to clamp overvoltage transients.

SYMBOL	PARAMETER	CONDITIONS	MIN.	MAX.	UNIT
I _{DRRM} E _{DSM}	Repetitive peak clamping drain current Non-repetitive inductive turn-off energy ²	$R_{IS} \ge 100 \ \Omega^{1}$ $I_{DM} = 15 \ A; \ R_{IS} \ge 100 \ \Omega$	-	15 200	A mJ
E _{DRM}	Repetitive inductive turn-off energy	$R_{IS} \ge 100 \ \Omega; \ T_{mb} \le 95 \ ^{\circ}C; \ I_{DM} = 4 \ A; \ V_{DD} \le 20 \ V; \ f = 250 \ Hz$	-	20	mJ
I _{DIRM}	Repetitive peak drain to input current ³	$R_{IS} = 0 \Omega; t_p \le 1 \text{ ms}$	-	50	mA

REVERSE DIODE LIMITING VALUE

SYMBOL	PARAMETER	CONDITIONS	MIN.	MAX.	UNIT
I _s	Continuous forward current	$T_{mb} = 25 ^{\circ}C;$ $V_{IS} = V_{PS} = V_{FS} = 0 V$	-	15	А

THERMAL CHARACTERISTICS

SYMBOL	PARAMETER	CONDITIONS	MIN.	TYP.	MAX.	UNIT
	Thermal resistance					
R _{th j-mb}	Junction to mounting base	-	-	2.5	3.1	K/W
R _{th j-a}	Junction to ambient	in free air	-	60	-	K/W

STATIC CHARACTERISTICS

T_{mb} = 25 °C unless otherwise specified

SYMBOL	PARAMETER	CONDITIONS		MIN.	TYP.	MAX.	UNIT
$V_{(CL)DSR}$	Drain-source clamping voltage	$R_{IS} = 100 \Omega; I_{D} = 10 \text{ m}$	nA	50	-	65	V
$V_{(CL)DSR}$	Drain-source clamping voltage	$R_{IS} = 100 \Omega; I_{DM} = 1 A;$ $\delta \le 0.01$; $t_p \le 300 \ \mu s$;	50	-	70	V
I _{DSS} I _{DSR} I _{DSR}	Zero input voltage drain current Drain source leakage current Drain source leakage current	$V_{DS} = 12 \text{ V}; V_{IS} = 0 \text{ V}$ $V_{DS} = 50 \text{ V}; R_{IS} = 100 \text{ V}$ $V_{DS} = 40 \text{ V}; R_{IS} = 100 \text{ V}$	Ω; Ω·	- -	0.5 1	10 20	μA μA
-DSK			$T_{j} = 125 ^{\circ}\text{C}$	-	10	100	μΑ
R _{DS(ON)}	Drain-source on-state resistance	$I_{DM} = 7.5 \text{ A};$ $t_p \le 300 \mu\text{s}; \ \delta \le 0.01$	$V_{IS} = 7 V$ $V_{IS} = 5 V$		75 95	100 125	$m\Omega$

¹ The input pin must be connected to the source pin by a specified external resistance to allow the power MOSFET gate source voltage to become sufficiently positive for active clamping. Refer to INPUT CHARACTERISTICS.

² While the protection supply voltage is connected, during overvoltage clamping it is possible that the overload protection may operate at energies close to the limiting value. Refer to OVERLOAD PROTECTION CHARACTERISTICS.

³ Shorting the input to source with low resistance inhibits the internal overvoltage protection by preventing the power MOSFET gate source voltage becoming positive.

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OVERLOAD PROTECTION CHARACTERISTICS

With adequate protection supply voltage TOPFET detects when one of the overload thresholds is exceeded.

Provided there is adequate input series resistance it switches off and remains latched off until reset by the protection supply pin. Refer also to OVERLOAD PROTECTION LIMITING VALUES and INPUT CHARACTERISTICS.

SYMBOL	PARAMETER	CONDITIONS	MIN.	TYP.	MAX.	UNIT
	Short circuit load protection ¹	$V_{PS} = V_{PSN}^2$; $T_{mb} = 25 ^{\circ}C$; L $\leq 10 \mu H$;				
$\mathbf{E}_{\mathrm{DS(TO)}}$ $\mathbf{t}_{\mathrm{d\ sc}}$	Overload threshold energy Response time	$V_{DD} = 13 \text{ V}; V_{IS} = 10 \text{ V}$ $V_{DD} = 13 \text{ V}; V_{IS} = 10 \text{ V}$		150 375	1 1	mJ μs
$T_{j(TO)}$	Over temperature protection Threshold junction temperature	$V_{PS} = V_{PSN}$; $R_1 \ge 2 \text{ k}\Omega$ from $I_D \ge 0.65 \text{ A}^3$	150	1	1	°C

TRANSFER CHARACTERISTICS

 $T_{mb} = 25 \, ^{\circ}C$

SYMBOL	PARAMETER	CONDITIONS	MIN.	TYP.	MAX.	UNIT
g_{fs}	Forward transconductance	$\begin{array}{l} V_{DS} = 10 \text{ V}; \ I_{DM} = 7.5 \text{ A } t_p \leq 300 \ \mu\text{s}; \\ \delta \leq 0.01 \end{array}$	5	9	-	S
I _D	Drain current⁴	$V_{DS} = 13 \text{ V}; \qquad V_{IS} = 5 \text{ V} $ $V_{IS} = 10 \text{ V}$	-	25 40	1 1	A A

PROTECTION SUPPLY CHARACTERISTICS

 T_{mb} = 25 °C unless otherwise specified

SYMBOL	PARAMETER	CONDITIONS		MIN.	TYP.	MAX.	UNIT
I _{PS} , I _{PSL}	Protection supply Protection supply current	normal operation or protection latched BUK104-50L	V _{PS} = 5 V	-	0.2	0.35	mA
V _{PSR}	Protection reset voltage ⁵	BUK104-50S T _i = 150 °C	$V_{PS} = 10 \text{ V}$	- 1.5 1.0	0.4 2.5	1.0 3.5	mA V V
V _{(CL)PS}	Protection clamp voltage	$I_p = 1.35 \text{ mA}$		1.0	13	, ,	V

REVERSE DIODE CHARACTERISTICS

 $T_{mb} = 25 \, ^{\circ}C$

SYMBOL	PARAMETER	CONDITIONS	MIN.	TYP.	MAX.	UNIT
V_{SDS}	Forward voltage	$I_S = 15 \text{ A}; V_{IS} = V_{PS} = V_{FS} = 0 \text{ V}; $ $t_p = 300 \mu\text{s}$	-	1.0	1.5	V
t _{rr}	Reverse recovery time	not applicable ⁶	-	-	-	-

¹ The short circuit load protection is able to save the device providing the instantaneous on-state dissipation is less than the limiting value for P_{DSM} , which is always the case when V_{DS} is less than V_{DSP} maximum.

² At the appropriate nominal protection supply voltage for each type. Refer to QUICK REFERENCE DATA.

³ The over temperature protection feature requires a minimum on-state drain source voltage for correct operation. The specified minimum I_D ensures this condition.

⁴ During overload condition. Refer also to OVERLOAD PROTECTION LIMITING VALUES and CHARACTERISTICS.

⁵ The supply voltage below which the overload protection circuits will be reset.

⁶ The reverse diode of this type is not intended for applications requiring fast reverse recovery.

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INPUT CHARACTERISTICS

T_{mb} = 25 °C unless otherwise specified

SYMBOL	PARAMETER	CONDITIONS		MIN.	TYP.	MAX.	UNIT
	Normal operation						
$V_{IS(TO)}$	Input threshold voltage	$V_{DS} = 5 \text{ V}; I_{D} = 1 \text{ I}$	mA T _{mb} = 150 °C	1.0 0.5	1.5 -	2.0	V V
$V_{(CL)IS}$	Input current Input clamp voltage	$V_{IS} = 10 \text{ V}$ $I_{I} = 1 \text{ mA}$. mb	- 11	10 13	100 -	nA V
	Overload protection latched						
R _{ISL}	Input resistance ¹	$V_{PS} = 5 V$ $V_{PS} = 10 V$	$I_{l} = 5 \text{ mA};$ $T_{mb} = 150 \text{ °C}$ $I_{l} = 5 \text{ mA};$	-	55 95 35	-	$\Omega \ \Omega \ \Omega$
		VPS = 10 V	$T_{mb} = 150 ^{\circ}C$	-	60	-	Ω
	Application information External input resistances for	(see figure 29)		100)
R _{IS}	internal overvoltage clamping ²	$R_1 = \infty \Omega;$	$V_{DS} > 30 \text{ V}$	100	-	-	Ω
R _I	internal overload protection ³	$R_{IS} = \infty \Omega;$	$V_{II} = 5 V$ $V_{II} = 10 V$	1 2	-	- -	kΩ kΩ

SWITCHING CHARACTERISTICS

 T_{mb} = 25 °C; R_{I} = 50 Ω ; R_{IS} = 50 Ω (see figure 29); resistive load R_{L} = 10 Ω . For waveforms see figure 28.

SYMBOL	PARAMETER	CONDITIONS	MIN.	TYP.	MAX.	UNIT
t _{d on}	Turn-on delay time	$V_{DD} = 15 \text{ V}; V_{IS}: 0 \text{ V} \Rightarrow 10 \text{ V}$	-	8	-	ns
t _r	Rise time		-	13	-	ns
t _{d off}	Turn-off delay time	$V_{DD} = 15 \text{ V}; V_{IS}: 10 \text{ V} \Rightarrow 0 \text{ V}$	-	100	-	ns
t _f	Fall time		-	45	-	ns

CAPACITANCES

 $T_{mb} = 25 \, ^{\circ}C; f = 1 \, MHz$

SYMBOL	PARAMETER	CONDITIONS	MIN.	TYP.	MAX.	UNIT
C _{iss}	Input capacitance	$V_{DS} = 25 \text{ V}; V_{IS} = 0 \text{ V}$	-	415	600	pF
C _{oss}	Output capacitance	$V_{DS} = 25 \text{ V}; V_{IS} = 0 \text{ V}$	-	275	400	pF
C _{rss}	Reverse transfer capacitance	$V_{DS} = 25 \text{ V}; V_{IS} = 0 \text{ V}$	-	55	80	pF
C _{pso}	Protection supply pin capacitance	V _{PS} = 10 V	-	30	-	pF
C _{fso}	Flag pin capacitance	V _{FS} = 10 V; V _{PS} = 0 V	-	20	-	pF

¹ The resistance of the internal transistor which discharges the power MOSFET gate capacitance when overload protection operates.

The external drive circuit should be such that the input voltage does not exceed $V_{IS(TO)}$ minimum when the overload protection has operated. Refer also to figure for latched input characteristics.

 $^{{\}bf 2}$ Applications using a lower value for $R_{\rm IS}$ would require external overvoltage protection.

³ For applications requiring a lower value for R_i, an external overload protection strategy is possible using the flag pin to 'tell' the control circuit to switch off the input.

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FLAG DESCRIPTION

The flag pin provides a means to detect the presence of the protection supply and indicate the state of the overload detectors. The flag is the open drain of an n-MOS transistor and requires an external pull-up resistor¹. It is suitable for both 5 V and 10 V logic. Flag may be used to implement an external protection strategy² for applications which require low input drive impedance.

TRUTH TABLE

CONDITION	DESCRIPTION	FLAG
NORMAL	Normal operation and adequate protection supply voltage	LOGIC LOW
OVER TEMP.	Over temperature detected	LOGIC HIGH
SHORT CIRCUIT	Overload condition detected	LOGIC HIGH
SUPPLY FAULT	Inadequate protection supply voltage	LOGIC HIGH

FLAG CHARACTERISTICS

 $T_{mb} = 25$ °C unless otherwise stated

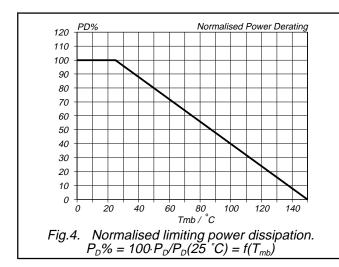
SYMBOL	PARAMETER	CONDITIONS	MIN.	TYP.	MAX.	UNIT
V _{FS}	Flag 'low' Flag voltage Flag saturation current	normal operation $I_F = 1.6 \text{ mA}$ $V_{FS} = 10 \text{ V}$	1 1	0.15 15	0.4 -	V mA
I _{FS} V _{PSF}	Flag 'high' Flag leakage current Protection supply threshold voltage	overload or fault V_{FS} = 10 V V_{FF} = 5 V; R_F = 3 k Ω ; BUK104-50L BUK104-50S	- 2.5 3.3	- 3.3 4.2	10 4 5	μ Α V V
$V_{(CL)FS}$	Flag clamping voltage	$I_F = 1 \text{ mA}; V_{PS} = 0 \text{ V}$	11	13	-	V
	Application information					
R _F	Suitable external pull-up resistance	$V_{FF} = 5 V$ $V_{FF} = 10 V$	1 2	10 20	50 100	kΩ kΩ

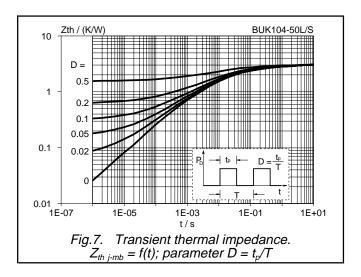
ENVELOPE CHARACTERISTICS

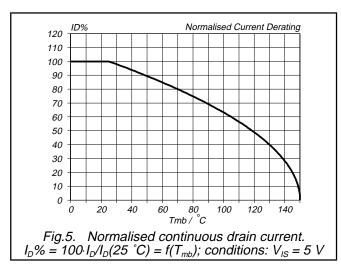
SYMBOL	PARAMETER	CONDITIONS	MIN.	TYP.	MAX.	UNIT
L _d	Internal drain inductance	Measured from contact screw on tab to centre of die	1	3.5	1	nΗ
L _d	Internal drain inductance	Measured from drain lead 6 mm from package to centre of die	-	4.5	-	nΗ
L _s	Internal source inductance	Measured from source lead 6 mm from package to source bond pad	-	7.5	1	nΗ

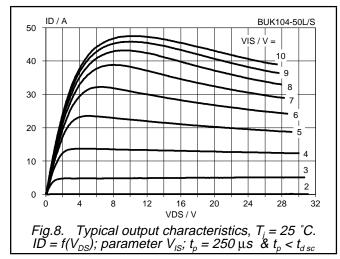
¹ Even if the flag pin is not used, it is recommended that it is connected to the protection supply via a pull-up resistor. It should not be left floating.

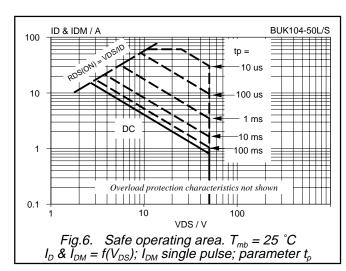
² Low pass filtering of the flag signal may be advisable to prevent false tripping.

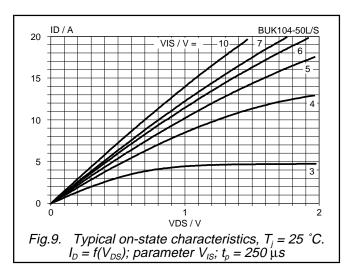


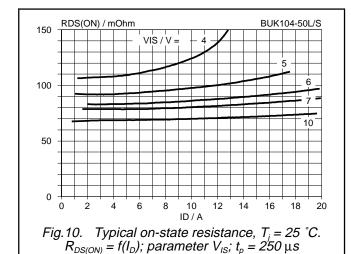












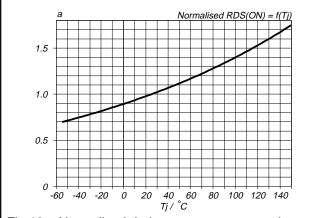


Fig.13. Normalised drain-source on-state resistance. $a = R_{DS(ON)}/R_{DS(ON)}25 \, ^{\circ}C = f(T_i); \, I_D = 7.5 \, A; \, V_{IS} \ge 5 \, V$

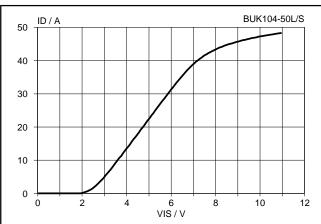


Fig.11. Typical transfer characteristics, T_i = 25 °C. I_D = $f(V_{IS})$; conditions: V_{DS} = 10 V; t_p = 250 μs

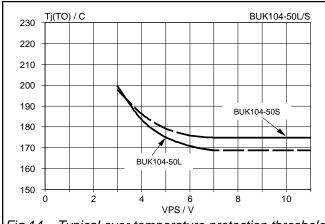


Fig.14. Typical over temperature protection threshold $T_{j(TO)} = f(V_{PS})$; conditions: $V_{DS} > 0.1 \text{ V}$

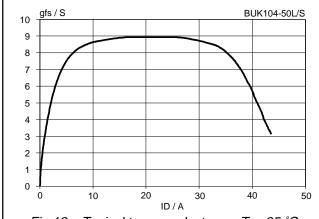


Fig.12. Typical transconductance, $T_j = 25$ °C. $g_{ts} = f(I_D)$; conditions: $V_{DS} = 10$ V; $t_p = 250$ μs

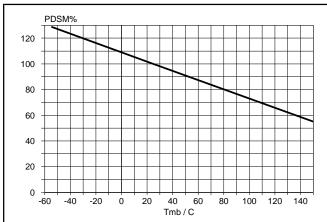


Fig.15. Normalised limiting overload dissipation. $P_{DSM}\% = 100 \cdot P_{DSM}/P_{DSM}(25 \, ^{\circ}C) = f(T_{mb})$

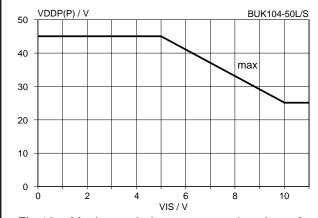


Fig.16. Maximum drain source supply voltage for SC load protection. $V_{DDP(P)} = f(V_{IS}); T_{mb} \le 150 \, ^{\circ}\text{C}$

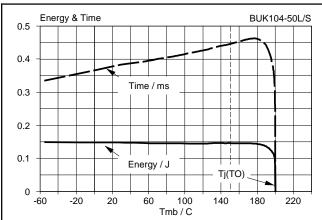


Fig.19. Typical overload protection characteristics. Conditions: $V_{DD} = 13 \text{ V}$; $V_{PS} = V_{PSN}$, $V_{IS} = 7 \text{ V}$; SC load

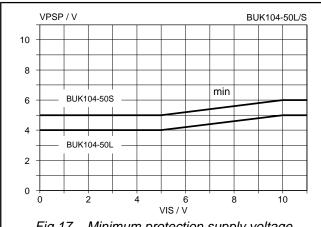


Fig.17. Minimum protection supply voltage for SC load protection. $V_{PSP} = f(V_{IS})$; $T_{mb} \ge 25 \, ^{\circ}C$

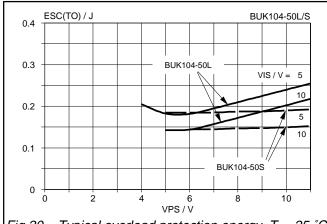


Fig.20. Typical overload protection energy, $T_j = 25$ °C $E_{SC(TO)} = f(V_{PS})$; conditions: $V_{DS} = 13$ V, parameter V_{IS}

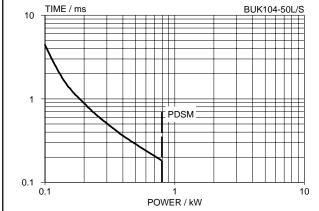


Fig.18. Typical overload protection characteristics. $t_{dsc} = f(P_{DS})$; conditions: $V_{PS} \ge V_{PSP}$; $V_{IS} \ge 5 \text{ V}$

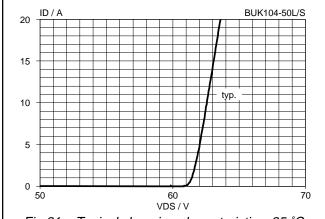
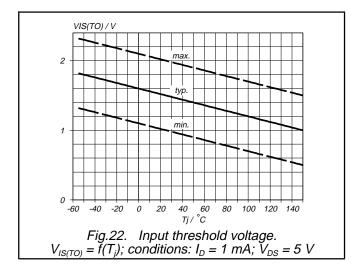


Fig.21. Typical clamping characteristics, 25 °C. $I_D = f(V_{DS})$; conditions: $R_{IS} = 100 \,\Omega$; $t_p \le 50 \,\mu s$



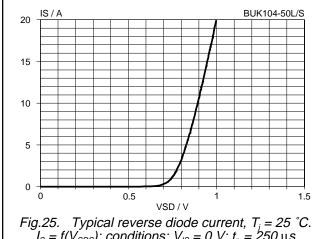


Fig.25. Typical reverse diode current, T_i = 25 °C. I_S = $f(V_{SDS})$; conditions: V_{IS} = 0 V; t_p = 250 μs

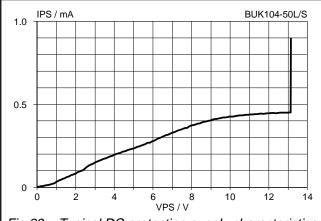


Fig.23. Typical DC protection supply characteristics. $I_{PS} = f(V_{PS})$; normal or overload operation; $T_i = 25 \, ^{\circ}\text{C}$

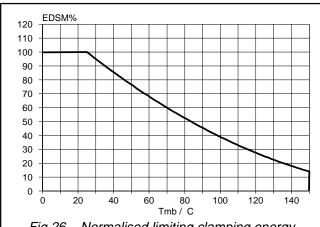


Fig.26. Normalised limiting clamping energy. $E_{DSM}\% = f(T_{mb})$; conditions: $I_D = 15$ A

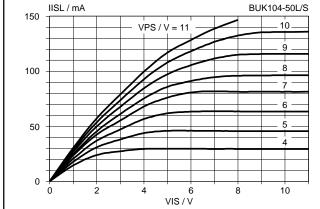


Fig.24. Typical latched input characteristics, 25 °C. $I_{ISL} = f(V_{IS})$; after overload protection latched

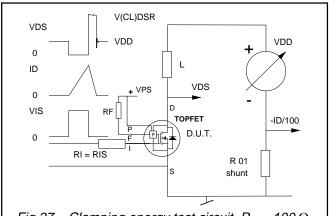
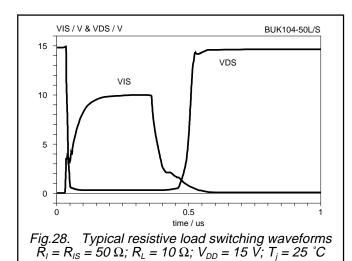
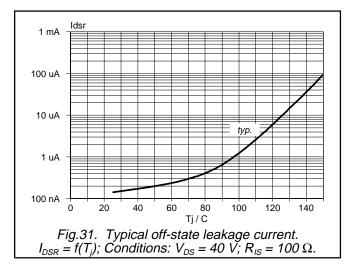
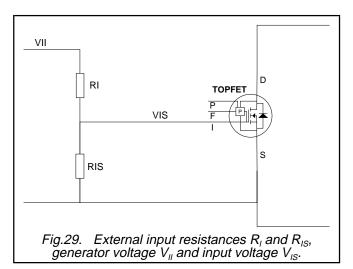
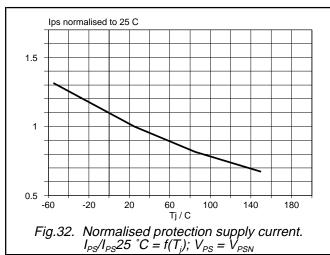


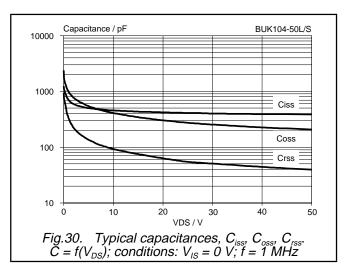
Fig.27. Clamping energy test circuit, $R_{IS} = 100 \Omega$. $E_{DSM} = 0.5 \cdot LI_D^2 \cdot V_{(CL)DSR} / (V_{(CL)DSR} - V_{DD})$



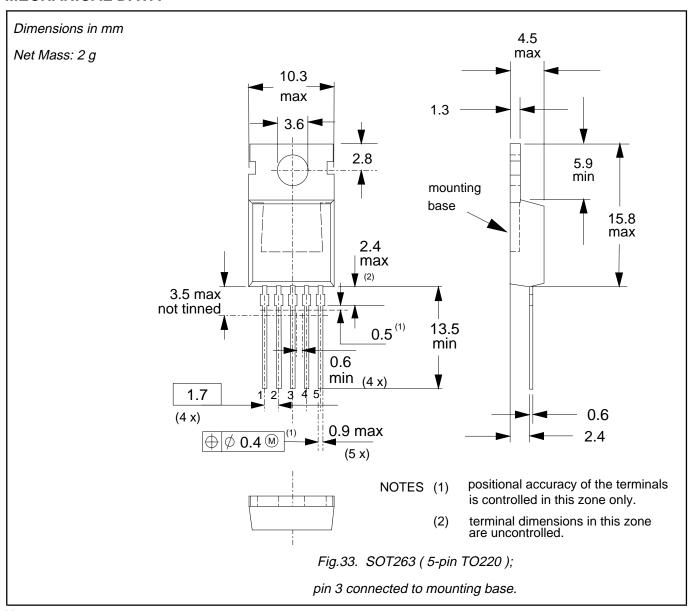






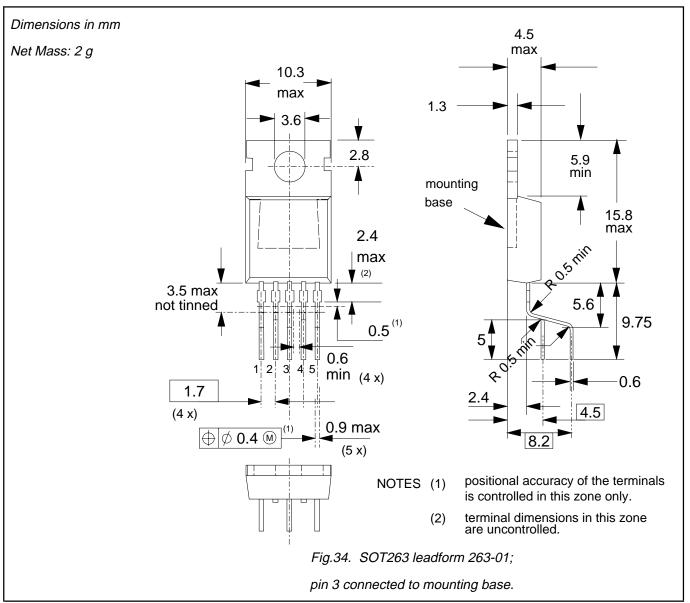


MECHANICAL DATA



- Refer to mounting instructions for TO220 envelopes.
 Epoxy meets UL94 V0 at 1/8".

MECHANICAL DATA



- Refer to mounting instructions for TO220 envelopes.
 Epoxy meets UL94 V0 at 1/8".

BUK104-50L/S BUK104-50LP/SP

DEFINITIONS

Data sheet status						
Objective specification	This data sheet contains target or goal specifications for product development.					
Preliminary specification	This data sheet contains preliminary data; supplementary data may be published later.					
Product specification	This data sheet contains final product specifications.					

Limiting values

Limiting values are given in accordance with the Absolute Maximum Rating System (IEC 134). Stress above one or more of the limiting values may cause permanent damage to the device. These are stress ratings only and operation of the device at these or at any other conditions above those given in the Characteristics sections of this specification is not implied. Exposure to limiting values for extended periods may affect device reliability.

Application information

Where application information is given, it is advisory and does not form part of the specification.

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